PCA9848BS

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset Rev. 2.3 — 26 September 2025

Product data sheet



Document information

Information	Content
Keywords	PCA9848BS, data sheet, I2C-bus, Fm+, ultra-low voltage, octal bidirectional translating switch
Abstract	The PCA9848BS is an ultra-low voltage, octal bidirectional translating switch controlled via the I2C-bus.



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

1 General description

The PCA9848BS is an ultra-low voltage, octal bidirectional translating switch controlled via the I2C-bus. The SCL/SDA upstream pair fans out to eight downstream pairs, or channels. Any or all SCx/SDx channels can be selected, determined by the programmable control register. This feature allows multiple devices with the same I2C-bus address to reside on the same bus. The switch device can also separate a heavily loaded I2C-bus into separate bus segments, eliminating the need for a bus buffer.

An active LOW reset input allows the PCA9848BS to recover from a situation where one of the downstream I2C-buses is stuck in a LOW state. Pulling the RESET pin LOW resets the I2C-bus state machine and deselects all the channels, as does the internal power-on reset (POR) function.

The pass gates of the switches are constructed such that the V_{DD1} pin is used to limit the maximum high voltage, which PCA9848BS passes. This situation allows the use of different bus voltages on each channel, so that 1.2 V, 1.8 V, 2.5 V, or 3.3 V parts can communicate without any additional protection. External pullup resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 3.6 V tolerant.

2 Features and benefits

- Ultra-low voltage operation, down to 1.08 V to interface with next-generation CPUs
- 1-of-8 bidirectional translating switch
- Fm+ I2C-bus interface logic; compatible with SMBus standards
- · Active LOW reset input
- Two address pins allow up to 16 devices on the I2C-bus
- · Channel selection via the I2C-bus
- · Power up with all switch channels deselected
- Low R_{on} switches
- Allows voltage level translation between 1.2 V, 1.8 V, 2.5 V, and 3.3 V buses
- · Reset via I2C-bus software command
- I2C Device ID function
- · No glitch on power up
- · Supports hot insertion since all channels are deselected at power on
- · Low standby current
- 3.6 V tolerant inputs
- 0 Hz to 1 MHz clock frequency
- ESD protection exceeds 6000 V HBM per JESD22-A114 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78, which exceeds 100 mA
- · Packages offered
 - HVQFN24

3 Ordering information

<u>Table 1</u> describes the ordering information for PCA9848BS.

Table 1. Ordering information

Type number	Topside	Package							
	marking	Name	Description	Version					
PCA9848BS	PCA9848	· ·	Plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 4 × 4 × 0.85 mm	SOT616-3					

PCA9848BS

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8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

3.1 Ordering options

Table 2 describes the ordering options for PCA9848BS.

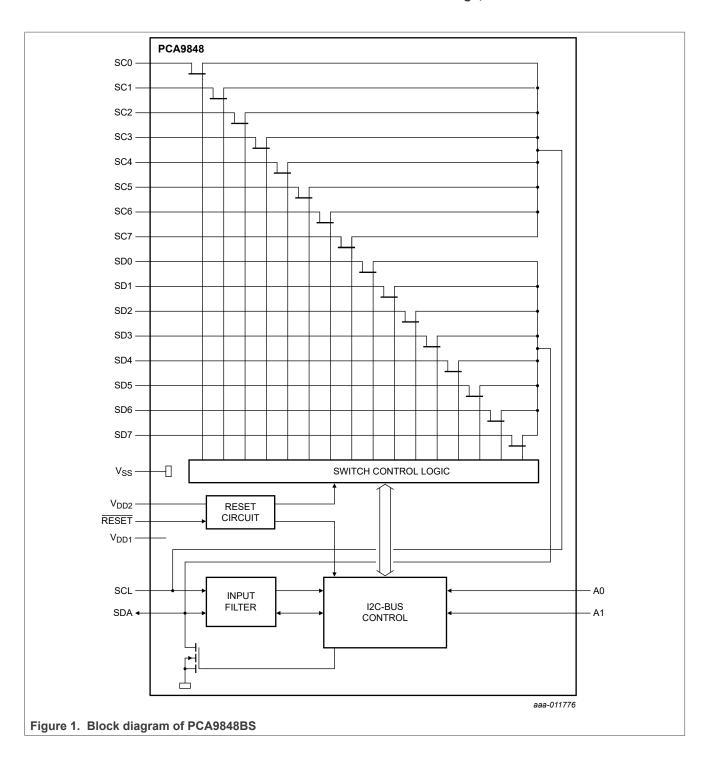
Table 2. Ordering options

Type number	Orderable part number	Package	3	Minimum order quantity	Temperature range
PCA9848BS	PCA9848BSMP	HVQFN24	Reel 13" Q2/T3 *Standard mark SMD	6000	T_{amb} = -40 °C to +125 °C

4 Block diagram

Figure 1 shows the labeled block diagram of PCA9848BS.

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset



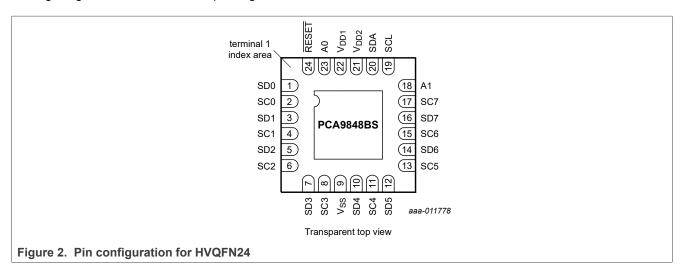
8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

5 Pinning information

This section provides the pin configuration and description for PCA9848BS.

5.1 Pinning

The figure given below shows the pinning for PCA9848BS.



5.2 Pin description

Table 3 provides detailed description of various pins on PCA9848BS.

Table 3. Pin description

Symbol	Pin	Description
SD0	1	Serial data 0
SC0	2	Serial clock 0
SD1	3	Serial data 1
SC1	4	Serial clock 1
SD2	5	Serial data 2
SC2	6	Serial clock 2
SD3	7	Serial data 3
SC3	8	Serial clock 3
V _{SS}	9 ^[1]	Supply ground
SD4	10	Serial data 4
SC4	11	Serial clock 4
SD5	12	Serial data 5
SC5	13	Serial clock 5
SD6	14	Serial data 6
SC6	15	Serial clock 6
SD7	16	Serial data 7

PCA9848BS

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8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

Table 3. Pin description...continued

Symbol	Pin	Description
SC7	17	Serial clock 7
A1	18	Address input 1
SCL	19	Serial clock line
SDA	20	Serial data line
V_{DD2}	21	Core logic power supply
V _{DD1}	22	Logic level power supply
A0	23	Address input 0
RESET	24	Active LOW reset input

^[1] HVQFN24 package die supply ground is connected to both the V_{SS} pin and the exposed center pad. The V_{SS} pin must be connected to the supply ground for proper device operation. For enhanced thermal, electrical, and board-level performance, the exposed pad must be soldered to the board using a corresponding thermal pad on the board. For proper heat conduction through the board, thermal vias must be incorporated in the printed-circuit board in the thermal pad region.

6 Functional description

Refer to Figure 1.

6.1 Device address

Following a START condition, the bus controller must output the address of the target it is accessing. The address of the PCA9848BS is shown in Figure 3. The device pins A0 and A1 must be connected to a valid logic signal — HIGH, LOW, SCL or SDA. This process ensures a valid target address, since no internal pullup resistors are provided.

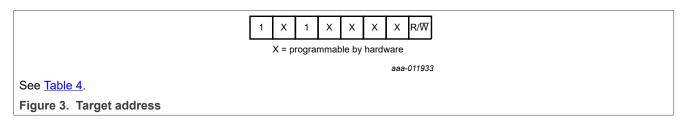


Table 4. Address selection

Addres	ss pins	8-bit I2C-	Target address/bit pattern controller must send								
A1	A0	bus address	A7	A6	A5	A4	А3	A2	A1	A0 - R/W	
0	SCL	0xE0h	1	1	1	0	0	0	0	0/1	
0	0	0xE2h	1	1	1	0	0	0	1	0/1	
0	SDA	0xE4h	1	1	1	0	0	1	0	0/1	
0	1	0xE6h	1	1	1	0	0	1	1	0/1	
1	SCL	0xE8h	1	1	1	0	1	0	0	0/1	
1	0	0xEAh	1	1	1	0	1	0	1	0/1	
1	SDA	0xECh	1	1	1	0	1	1	0	0/1	
1	1	0xEEh	1	1	1	0	1	1	1	0/1	

PCA9848BS

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8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

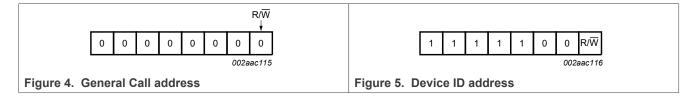
Table 4. Address selection...continued

Addres	ss pins	8-bit I2C-		Tai	rget addre	ess/bit pat	tern cont	roller mu	st send	
A1	A0	bus address	A7	A6	A5	A4	А3	A2	A1	A0 - R/W
SCL	SCL	0xB0h	1	0	1	1	0	0	0	0/1
SCL	0	0xB2h	1	0	1	1	0	0	1	0/1
SCL	SDA	0xB4h	1	0	1	1	0	1	0	0/1
SCL	1	0xB6h	1	0	1	1	0	1	1	0/1
SDA	SCL	0xB8h	1	0	1	1	1	0	0	0/1
SDA	0	0xBAh	1	0	1	1	1	0	1	0/1
SDA	SDA	0xBCh	1	0	1	1	1	1	0	0/1
SDA	1	0xBEh	1	0	1	1	1	1	1	0/1

6.2 Software Reset General Call and Device ID addresses

Two other different addresses can be sent to the device.

- General Call address: It allows resetting the device through the I2C-bus upon reception of the right I2C-bus sequence. See <u>Section 6.2.1</u> for more information.
- Device ID address: It allows reading ID information from the device (manufacturer, part identification, revision). See <u>Section 6.2.2</u> for more information.



6.2.1 Software Reset

The Software Reset Call allows all the devices in the I2C-bus to be reset to the power up state value through a specific formatted I2C-bus command. To be performed correctly, it implies that the I2C-bus is functional and that there is no device hanging the bus.

The Software Reset sequence is defined as the following:

- 1. The I2C-bus controller sends a START command.
- 2. The I2C-bus controller sends the reserved General Call I2C-bus address '0000 000' with the R/W bit set to 0 (write).
- 3. The device acknowledges after seeing the General Call address '0000 0000' (00h) only. If the R/W bit is set to 1 (read), no acknowledge is returned to the I2C-bus controller.
- 4. Once the General Call address has been sent and acknowledged, the controller sends 1 byte. The value of the byte must be equal to 06h.
- 5. The device acknowledges this value only. If the byte is not equal to 06h, the device does not acknowledge it.

If more than 1 byte of data is sent, the device does not acknowledge anymore.

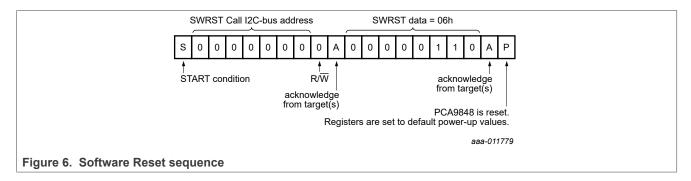
Once the right byte has been sent and correctly acknowledged, the controller sends a STOP command to
end the Software Reset sequence: the device then resets to the default value (power up value) and is ready
to be addressed again within the specified bus free time. If the controller sends a Repeated START instead,
no reset is performed.

PCA9848BS

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

The I2C-bus controller must interpret a non-acknowledge from the device (at any time) as a 'Software Reset Abort'. The device does not initiate a reset of its registers.

The unique sequence that initiates a Software Reset is described in Figure 6.



6.2.2 Device ID (PCA9848BS ID field)

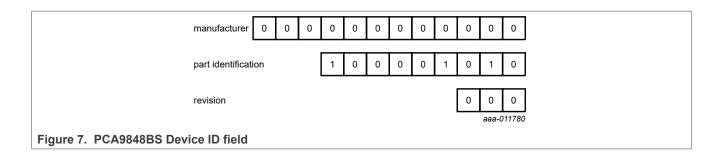
The Device ID field is a 3-byte read-only (24 bits) word giving the following information:

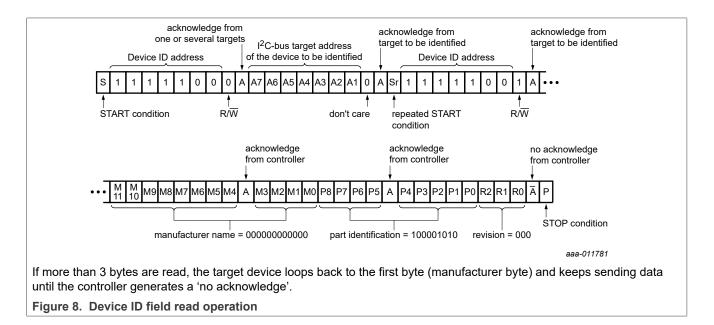
- 12 bits with the manufacturer name, unique per manufacturer (for example, NXP).
- 9 bits with the part identification, assigned by manufacturer.
- 3 bits with the die revision, assigned by manufacturer (for example, Rev X).

The Device ID is read-only, hardwired in the device and can be accessed as follows:

- 1. START command
- 2. The controller sends the Reserved Device ID I2C-bus address followed by the R/W bit set to 0 (write): '1111 1000'.
- 3. The controller sends the I2C-bus target address of the target device that it must identify. The LSB is a 'Don't care' value. Only one device must acknowledge this byte (the one that has the I2C-bus target address).
- 4. The controller sends a Re-START command.
 - **Remark:** A STOP command followed by a START command resets the target state machine and the Device ID read cannot be performed. Also, a STOP command or a Re-START command followed by access to another target device resets the target state machine and the Device ID Read cannot be performed.
- 5. The controller sends the Reserved Device ID I2C-bus address followed by the R/W bit set to 1 (read): '1111 1001'.
- 6. The Device ID Read can be done, starting with the 12 manufacturer bits (first byte + 4 MSB of the second byte), followed by the 9 part identification bits (4 LSBs of the second byte + 5 MSBs of the third byte), and then the 3 die revision bits (3 LSBs of the third byte).
- 7. The controller ends the reading sequence by NACKing the last byte, therefore resetting the target device state machine and allowing the controller to send the STOP command.
 - **Remark:** The reading of the Device ID can be stopped anytime by sending a NACK command. If the controller continues to ACK the bytes after the third byte, the target rolls back to the first byte and keeps sending the Device ID sequence until a NACK has been detected. For the PCA9848BS, the Device ID is shown in Figure 7.

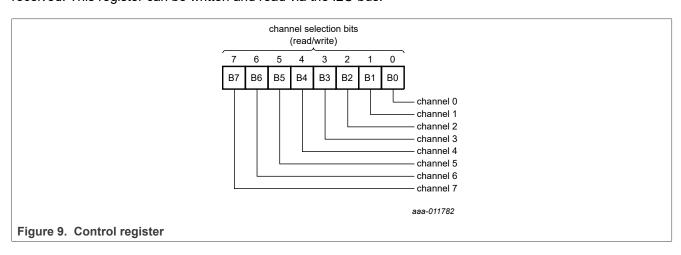
8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset





6.3 Control register

Following the successful acknowledgment of the target address, the bus controller sends a byte to the PCA9848BS, which is stored in the control register. If PCA9848BS receives multiple bytes, it saves the last byte received. This register can be written and read via the I2C-bus.



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

6.3.1 Control register definition

The contents of the control register select a SCx/SDx downstream pair, or channel. This register is written after the PCA9848BS has been addressed. All 8 bits of the control byte are used to determine which channel or channels are to be selected. When a channel is selected, it will become active after a STOP condition has been placed on the I2C-bus. This operation ensures that all SCx/SDx lines are in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection. Notice that multiple channels can be simultaneously selected.

Table 5. Control register

Write = channel selection; Read = channel status

B7	В6	B5	B4	В3	B2	B1	В0	Command
Х	Х	Х	Х	Х	Х	Х	0	Channel 0 disabled
^	^	^	^	^	^	^	1	Channel 0 enabled
X	Х	Х	Х	Х	Х	0	Х	Channel 1 disabled
^	^	^	^	^	^	1	^	Channel 1 enabled
Х	Х	Х	Х	Х	0	Х	Х	Channel 2 disabled
^	^	^	^	^	1	^	_ ^	Channel 2 enabled
Х	Х	Х	Х	0	X	Х	х	Channel 3 disabled
^	^	^	^	1	1 ^	^	^	Channel 3 enabled
V	V	V	0	V	Х	V	V	Channel 4 disabled
X	X	X	1	X	^	X	X	Channel 4 enabled
Х	Х	0	Х	Х	Х	Х	х	Channel 5 disabled
^	^	1	^	^	^	^	^	Channel 5 enabled
Х	0	Х	Х	Х	Х	Х	Х	Channel 6 disabled
^	1	^	^	^	^	^	^	Channel 6 enabled
0	Х	Х	Х	Х	Х	Х	x	Channel 7 disabled
1	^	^	^	^	^	^	^	Channel 7 enabled

Remark: Multiple channels can be enabled at the same time. Example: B7 = 0, B6 = 1, B5 = 0, B4 = 0, B3 = 1, B2 = 1, B1 = 0, B0 = 0, means that channels 7, 5, 4, 1 and 0 are disabled and channels 6, 3, and 2 are enabled. Care must be taken not to exceed the maximum bus capacitance. The default condition is all zeroes.

6.4 RESET input

The $\overline{\text{RESET}}$ input is an active LOW signal, which can be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of $t_{\text{W(rst)L}}$, the PCA9848BS resets its registers and I2C-bus state machine and deselects all channels.

6.5 Power-on reset

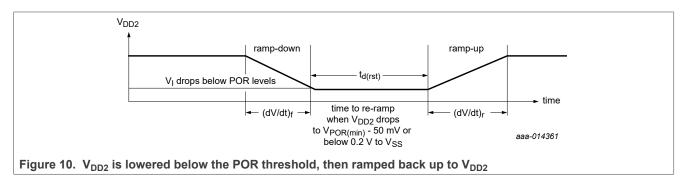
When power is applied to V_{DD} , an internal power-on reset (POR) holds the PCA9848BS in a reset condition until V_{DD2} has reached V_{POR} . At this point, the reset condition is released and the PCA9848BS registers and I2C-bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected.

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

6.6 Power-on reset requirements

In the event of a glitch or data corruption, PCA9848BS can be reset to its default conditions by using the poweron reset feature. Power-on reset requires that the device goes through a power cycle to be reset. This reset also happens when the device is powered on for the first time in an application.

Power-on reset is shown in Figure 10.



<u>Table 6</u> specifies the performance of the power-on reset feature for PCA9848BS for both types of power-on reset.

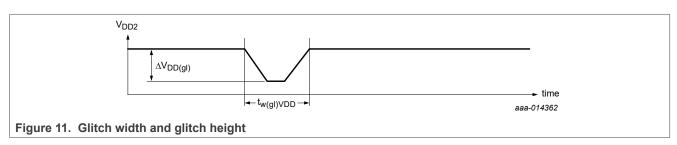
Table 6. Recommended supply sequencing and ramp rates

T_{amb} = 25 °C (unless otherwise noted). Not tested; specified by design.

Symbol	Parameter	Condition		Min	Тур	Max	Unit
(dV/dt) _f	Fall rate of change of voltage	Figure 10		0.1	-	2000	ms
(dV/dt) _r	Rise rate of change of voltage	Figure 10		0.1	-	2000	ms
t _{d(rst)}	Reset delay time	Figure 10; re-ramp time when V_{DD2} drops to $V_{POR(min)}$ - 50 mV) or below 0.2 V to V_{SS}		1	-	-	μs
$\Delta V_{DD(gl)}$	Glitch supply voltage difference	Figure 11	[1]	-	-	1.0	V
t _{w(gl)VDD}	Supply voltage glitch pulse width	Figure 11	[2]	-	-	10	μs
V _{POR(trip)}	Power-on reset trip voltage	Falling V _{DD2}		0.7	-	-	V
		Rising V _{DD2}		-	-	1.5	V

^[1] Level that V_{DD2} can glitch down to with a ramp rate = 0.4 μ s/V, but not cause a functional disruption when $t_{w(gl)VDD}$ < 1 μ s.

Glitches in the power supply can also affect the power-on reset performance of this device. The glitch width $(t_{w(gl)VDD})$ and glitch height $(\Delta V_{DD(gl)})$ depend on each other. The bypass capacitance, source impedance, and device impedance are factors that affect power-on reset performance. Figure 11 and Table 6 provide more information on how to measure these specifications.



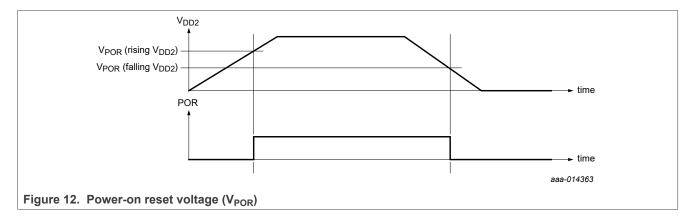
PCA9848BS

11 / 28

^[2] Glitch width that does not cause a functional disruption when $\Delta V_{DD(gl)}$ = 0.5 × V_{DD2} .

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

 V_{POR} is critical to the power-on reset. V_{POR} is the voltage level at which the reset condition is released and all the registers and I2C-bus/SMBus state machine are initialized to their default states. The value of V_{POR} differs based on the V_{DD2} being lowered to or from 0 V. Figure 12 and Table 6 provide more details on this specification.



6.7 Voltage level translation between I2C-buses

Complex systems often use multiple power supplies to maximize power savings and to meet the operating specifications of the devices used. This means that various I2C-buses are also operating at differing voltage levels and cannot simply connect. In addition, modern microcontrollers operate down to 1.08 V to save power, further complicating the connection of I2C-buses.

The PCA9848BS is designed to handle these voltage level translation issues seamlessly. Any combination of bus voltages can be intermixed on PCA9848BS and correctly translated to the other bus at Fm+ (1 MHz) speed.

Figure 13 shows a typical application. The microcontroller acts as the controller and operates at 1.2 V with its I2C-bus swinging between 0 V and 1.2 V. The temperature sensor on channel 0 of the PCA9848BS operates at 3.3 V, while the GPIO Expander on channel 1 operates down to 1.8 V to interface with chip select and reset inputs on various other ICs also operating at 1.8 V. Channel 2 of the PCA9848BS is connected to the I2C-bus of a power management device, operating at 2.5 V. The other channels of PCA9848BS are left unconnected.

In this example, V_{DD1} of the PCA9848BS is a bias supply and is set at the lowest bus voltage, or 1.2 V of the microcontroller. V_{DD1} sets the input switching points of each SCL and SDA, at 0.3 × V_{DD1} for a LOW level and 0.7 × V_{DD1} for a HIGH level.

V_{DD2} is the core logic supply from which most of the PCA9848BS circuitry runs and must be larger than 1.65 V.

The I2C-bus is open-drain, so pullup resistors are needed on each I2C-bus segment. This condition is where the voltage level translation happens. The pass transistor internal to the PCA9848BS limit the output voltage to the lower of V_{DD1} or V_{DD2} . The pullup resistors limit the HIGH level of each bus segment to the power supply of devices on that segment. The pullup resistors on channel 0 are connected to 3.3 V, and the resistors on channel 1 are connected to 1.8 V, while the resistors on channel 2 are connected to 2.5 V — effectively translating the 1.08 V signal swing of the microcontroller to the correct voltage level for each peripheral.

It is possible to level shift from a higher voltage microcontroller connected to V_{DD1} to lower voltage peripherals on the downstream side — the opposite of this particular example, as long as $V_{DD1} > 1.08$ V and $V_{DD2} > 1.65$ V.

One thing to note is that the noise margin on each I2C-bus segment is reduced due to the input levels set by V_{DD1} . Especially, in this example, the I2C-bus LOW level is $0.3 \times V_{DD1}$ or $0.33 \, \text{V}$, so extreme care must be taken to ensure that all bus segments meet this specification. It also means that if the offset side is connected to the PCA9848BS, the static offset buffers cannot work correctly.

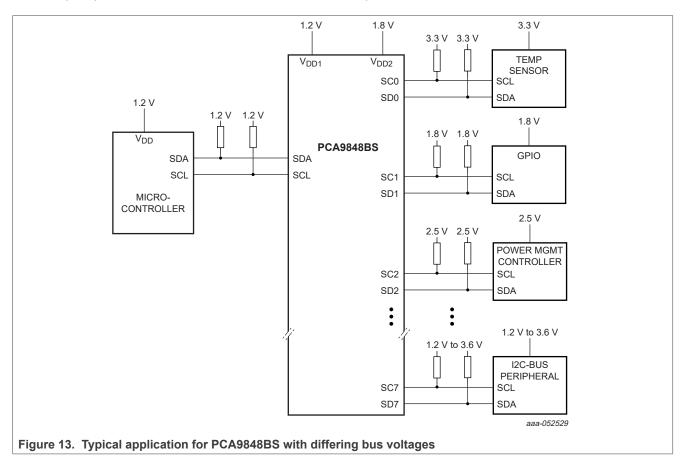
Another point to examine is that there is no buffering capability between the upstream and the downstream buses. It is simply a pass transistor, which acts like a switch and a series resistor, between these bus segments.

PCA9848B

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

The series resistance is the R_{on} of the pass transistor and is inversely proportional to the minimum of V_{DD2} . Refer to <u>Table 8</u> for some representative R_{on} values. An upcoming application note explains R_{on} more thoroughly. Therefore, a careful analysis of bus capacitance and pullup resistor values is called for.

A further point to consider is pullup resistor selection. Since multiple channels can be simultaneously selected, the pullup resistors on each channel are connected in parallel. Ensure that each device can correctly drive the effective pullup resistor value and still meet the LOW-level specifications.



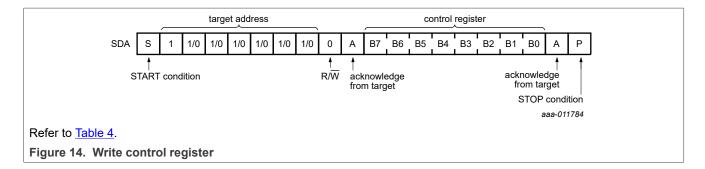
7 Characteristics of the I2C-bus

The PCA9848BS is an I2C target device. Data is exchanged between the controller and the PCA9848BS through write and read commands conforming to the I2C-bus protocol. The two communication lines are SCL (serial clock) and SDA (serial data), both of which must be connected to V_{DD1} through pullup resistors.

7.1 Write commands

Data is transmitted to the PCA9848BS by sending its device address and setting the least significant bit (LSB) to a logic 0 (see <u>Table 4</u> for device addresses), which the PCA9848BS acknowledges (ACK). To determine which channels are selected, refer <u>Section 6.3.1</u>. There is no limit on the number of bytes sent after the address and before a STOP condition. Only the last byte written before the STOP condition is recognized and the selected channel is enabled only at the following STOP condition.

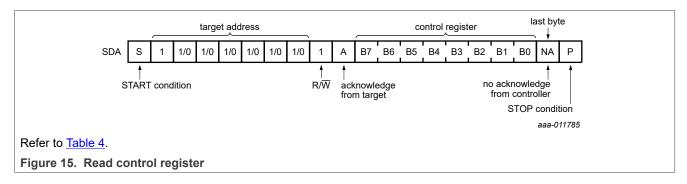
8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset



7.2 Read commands

Data is read from the PCA9848BS by sending its device address and setting the least significant bit (LSB) to a logic 1 (see <u>Table 4</u> for device addresses), which the PCA9848BS acknowledges. The controller reads the control register byte, with each byte either ACK or NACK by the controller. If the controller acknowledges the control register byte, it continues to send register data until the controller NACKs, signaling the transaction is complete. There is no limit on the number of bytes read from the PCA9848BS.

The control register bit definitions are shown in <u>Figure 9</u>. Bit 0 through bit 2 shows the enabled channels (as determined by the last write).



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

8 Limiting values

Table 7 describes the limiting values of PCA9848BS.

Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Voltages are referenced to V_{SS} (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	Supply voltage		-0.5	+4.0	V
VI	Input voltage		-0.5	+4.0	V
I _I	Input current		-	±20	mA
Io	Output current		-	±25	mA
I _{DD}	Supply current		-	±100	mA
I _{SS}	Ground supply current		-	±100	mA
P _{tot}	Total power dissipation		-	400	mW
T _{stg}	Storage temperature		-60	+150	°C
T _{amb}	Ambient temperature	PCA9848BS operating	-40	+125	°C

^[1] The performance capability of a high-performance integrated circuit with its thermal environment can create junction temperatures, which are detrimental to reliability. The maximum junction temperature of this integrated circuit must not exceed 150 °C.

9 Static characteristics

This section describes the static characteristics of PCA9848BS.

Table 8. Static characteristics

 V_{SS} = 0 V; T_{amb} = -40 °C to +125 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply					'	
V_{DD1}	Supply voltage 1		1.08	-	3.6	V
V_{DD2}	Supply voltage 2		1.65	-	3.6	V
I _{DD(VDD2)}	Supply current on pin V _{DD2}	V_{DD1} = 3.6 V, V_{DD2} = 3.6 V; SC0 to SC7 and SD0 to SD7 not connected; RESET = V_{DD1} ; A0 = A1 = SCL; continuous register read/write				
		f _{SCL} = 0 kHz	-	5	12	μA
		f _{SCL} = 100 kHz	-	8	20	μΑ
		f _{SCL} = 1000 kHz	-	65	150	μA
I _{DD(VDD1)}	Supply current on pin V _{DD1}	V_{DD1} = 3.6 V, V_{DD2} = 3.6 V; SC0 to SC7 and SD0 to SD7 not connected; RESET = V_{DD1} ; A0 = A1 = SCL; continuous register read/write				
		f _{SCL} = 0 kHz	-5	-2	+2	μΑ

PCA9848B

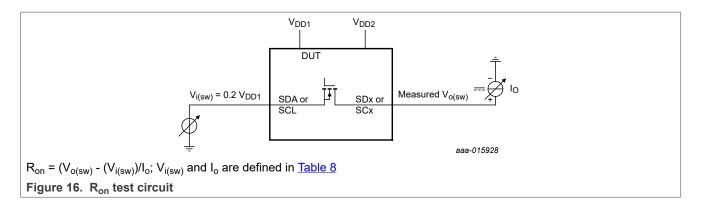
8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

Table 8. Static characteristics...continued

 V_{SS} = 0 V; T_{amb} = -40 °C to +125 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		f _{SCL} = 100 kHz	-	5	15	μΑ
		f _{SCL} = 1000 kHz	-	45	100	μΑ
V _{POR}	Power-on reset voltage		-	1.2	1.5	V
Input SCI	_; input/output SDA					
V _{IL}	LOW-level input voltage	V _{DD1} ≤ 1.1 V	-0.5	-	+0.2V _{DD1}	V
		V _{DD1} > 1.1 V	-0.5	-	+0.3V _{DD1}	V
V _{IH}	HIGH-level input voltage	V _{DD1} = ≤ 1.1 V	0.8V _{DD1}	-	3.6	V
		V _{DD1} > 1.1 V	0.7V _{DD1}	-	3.6	V
I _{OL}	LOW-level output current	V _{OL} = 0.4 V; V _{DD2} ≤ 2 V	15	-	-	mA
		V _{OL} = 0.4 V; V _{DD2} > 2 V	20	-	-	mA
IL	Leakage current	V _I = V _{DD} or V _{SS}	-1	-	+1.5	μA
C _i	Input capacitance	V _I = V _{SS} ; all channels disabled	-	20	40	pF
Select in	outs A0 to A1, RESET		1			
V _{IL}	LOW-level input voltage	V _{DD1} ≤ 1.1 V	-0.5	-	+0.2V _{DD1}	V
		V _{DD1} > 1.1 V	-0.5	-	+0.3V _{DD1}	V
V _{IH}	HIGH-level input voltage	V _{DD1} ≤ 1.1 V	0.8V _{DD1}	-	3.6	
		V _{DD1} > 1.1 V	0.7V _{DD1}	-	3.6	V
I _{LI}	Input leakage current	Pin at V _{DD2} to 3.6 V or V _{SS}	-1	-	+1.5	μΑ
Ci	Input capacitance	$V_I = V_{SS}$ or V_{DD1}	-	5	10	pF
Pass gate	e		1			
R _{on}	ON-state resistance	ON resistance of the pass transistor between SCL and SCx, and SDA and SDx				
		V_{DD1} = 1.08 V; $V_{DD2} \ge$ 1.65 V; $V_{i(sw)}$ = 0.16 V; I_{O} = 3 mA	-	15	24	Ω
		V_{DD1} = 1.2 V; $V_{DD2} \ge$ 1.8 V; $V_{i(sw)}$ = 0.24 V; I_{O} = 6 mA	-	12	18	Ω
		$V_{DD1} > 2 \text{ V; } V_{DD2} \ge 2.5 \text{ V; } V_{i(sw)} = 0.4$ V; $I_{O} = 20 \text{ mA}$	-	7	12	Ω
I _{o(sw)}	Switch output current	V_{DD2} = 1.65 V to 3.6 V; $V_{i(sw)}$ = V_{DD1} to 3.6 V; $V_{o(sw)}$ = V_{DD1} to 3.6 V	0	-	100	μA
IL	Leakage current	V _I = V _{DD} or V _{SS}	-1	-	+1.5	μA
C _{io}	Input/output capacitance	V _I = V _{SS} ; all switches disabled	-	8	15	pF

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset



10 Dynamic characteristics

This section describes the dynamic characteristics of PCA9848BS.

Table 9. Dynamic characteristics

Symbol	Parameter	Conditions		Standard- mode I2C-bus		Fast-mode I2C-bus		Fast-mode Plus I2C-bus		Unit
				Min	Max	Min	Max	Min	Max	
t _{PD}	Propagation delay	From SDA to SDx, or SCL to SCx		-	1 ^[1]	-	1 ^[1]	-	1 ^[1]	ns
f _{SCL}	SCL clock frequency			0	100	0	400	0	1000	kHz
t _{BUF}	Bus free time between a STOP and START condition			4.7	-	1.3	-	0.5	-	μs
t _{HD;STA}	Hold time (repeated) START condition		[2]	4.0	-	0.6	-	0.26	-	μs
t _{LOW}	LOW period of the SCL clock			4.7	-	1.3	-	0.5	-	μs
t _{HIGH}	HIGH period of the SCL clock			4.0	-	0.6	-	0.26	-	μs
t _{SU;STA}	Set-up time for a repeated START condition			4.7	-	0.6	-	0.26	-	μs
t _{SU;STO}	Set-up time for STOP condition			4.0	-	0.6	-	0.26	-	μs
t _{HD;DAT}	Data hold time			0 ^[3]	3.45	0 ^[3]	0.9	0	-	μs
t _{SU;DAT}	Data set-up time			250	-	100	-	50	-	ns
t _r	Rise time of both SDA and SCL signals			-	1000	20 × (V _{DD} /5.5 V) ^[4]	300	-	120	ns
t _f	Fall time of both SDA and SCL signals			-	300	20 × (V _{DD} /5.5 V) ^[4]	300	20 × (V _{DD} /5.5 V) ^[4]	120 ^[5]	ns
C _b	Capacitive load for each bus line			-	400	-	400	-	550	pF
t _{SP}	Pulse width of spikes that must be suppressed by the input filter			-	50	-	50	0	50 ^[6]	ns

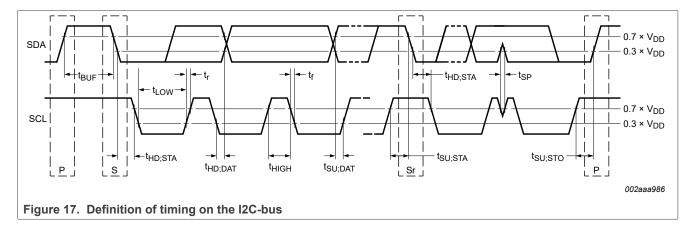
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Table 9. Dynamic characteristics...continued

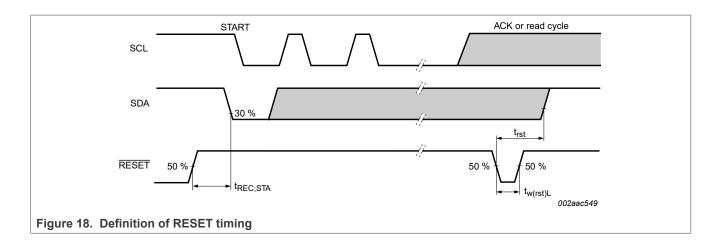
Symbol	Parameter	Conditions		Standard- mode I2C-bus		Fast-mode I2C-bus		Fast-mode Plus I2C-bus		Unit
				Min	Max	Min	Max	Min	Max	
t _{VD;DAT}	Data valid time		[7]	-	3.45	-	0.9	-	0.45	μs
t _{VD;ACK}	Data valid acknowledge time			-	1	-	1	-	0.45 ^[8]	μs
RESET								,		
t _{w(rst)L}	LOW-level reset time			100	-	100	-	100	-	ns
t _{rst}	Reset time	SDA clear		500	-	500	-	500	-	ns
t _{REC;STA}	Recovery time to START condition			0	-	0	-	0	-	ns

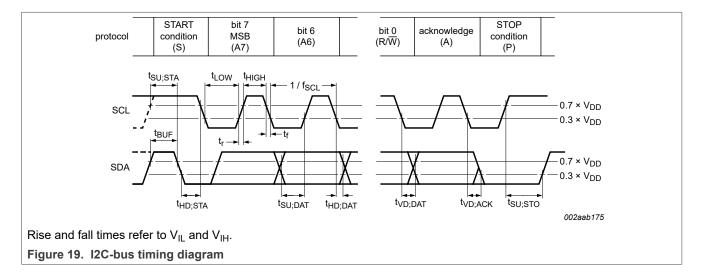
- Pass gate propagation delay is calculated from the 20 Ω typical R_{on} and the 50 pF load capacitance. After this period, the first clock pulse is generated.
- [2]
- A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIH(min) of the SCL signal) to bridge the undefined region [3] of the falling edge of SCL.
- [4]
- Necessary to be backward-compatible to Fast-mode.

 In Fast-mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers must allow it when [5] considering bus timing.
- Input filters on the SDA and SCL inputs suppress noise spikes of less than 50 ns. Measurements taken with 1 k Ω pullup resistor and 50 pF load.
- [7]
- The maximum $t_{\text{HD;DAT}}$ could be 3.45 μs and 0.9 μs for Standard-mode and Fast-mode, but must be less than the maximum of $t_{\text{VD;DAT}}$ or $t_{\text{VD;ACK}}$ by a transition time. This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretches the SCL, the [8] data must be valid by the set-up time before it releases the clock.



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

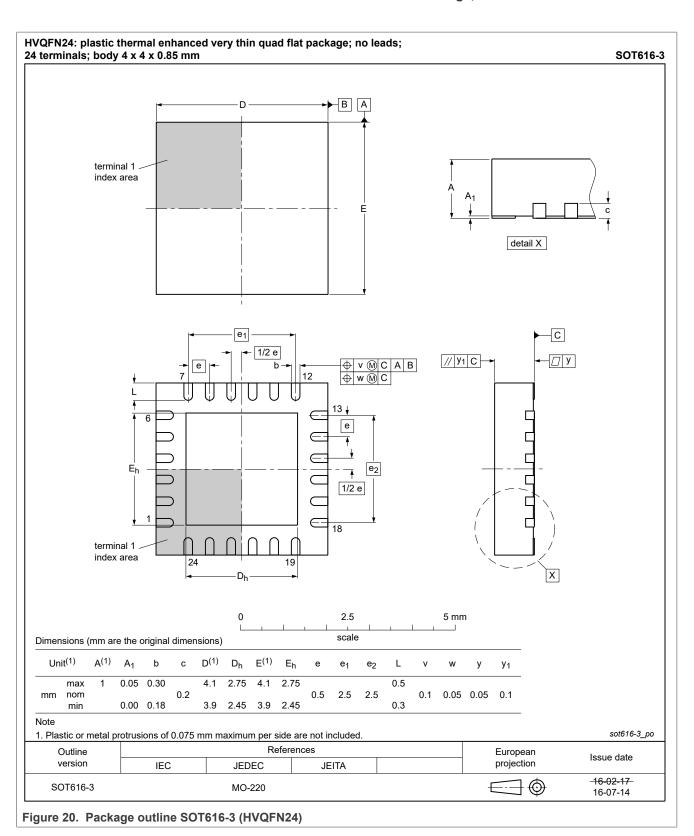




11 Package outline

This section includes an illustration of the package outline for PCA9848BS.

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

12 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

12.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

12.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- · Inspection and repair
- · Lead-free soldering versus SnPb soldering

12.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

12.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see Figure 21) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board

PCA9848BS

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak
temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to
make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low
enough that the packages and/or boards are not damaged. The peak temperature of the package depends on
package thickness and volume and is classified in accordance with <u>Table 10</u> and <u>Table 11</u>

Table 10. SnPb eutectic process (from J-STD-020D)

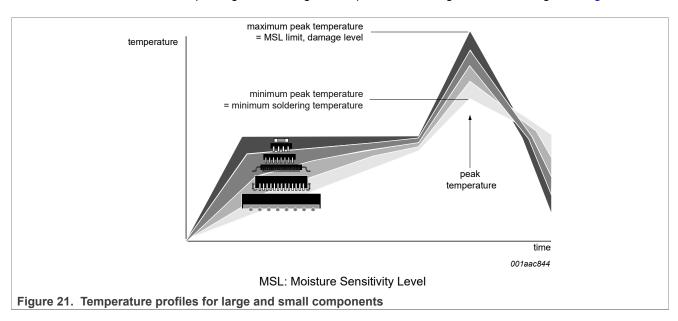
Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350	≥ 350			
< 2.5	235	220			
≥ 2.5	220	220			

Table 11. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature						
	Volume (mm³)						
	< 350	350 to 2000	> 2000				
< 1.6	260	260	260				
1.6 to 2.5	260	250	245				
> 2.5	250	245	245				

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 21.

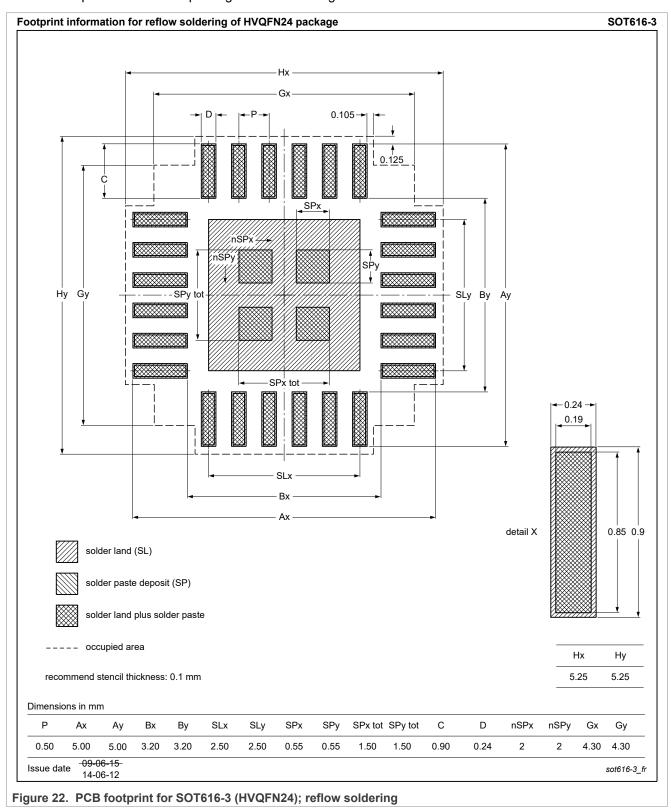


For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

13 Soldering: PCB footprints

This section provides PCB footprint figures for soldering the PCA9848BS.



8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

14 Acronyms

Table 12 describes the acronyms used in this data sheet.

Table 12. Acronyms

Acronym	Description
CDM	Charged-device model
ESD	Electrostatic discharge
НВМ	Human body model
I2C-bus	Inter-Integrated Circuit bus
LSB	Least significant bit
MSB	Most significant bit
PCB	Printed-circuit board
SMBus	System management bus

15 Revision history

Table 13 summarizes revisions to this document.

Table 13. Revision history

Document ID	Release date	Description
PCA9848BS v.2.3	26 September 2025	Updated per CIN# 202508016I: • Modified Section 7.1 as per CIN #202508016I • Editorial fixes
PCA9848BS v.2.2	23 October 2023	Product data sheet
PCA9848BS v.2.1	30 August 2023	Product data sheet
PCA9848 v.2.0	16 May 2023	Product data sheet as per CIN #202212010I
PCA9848 v.1.1	2 November 2016	Product data sheet
PCA9848 v.1.0	15 December 2014	Product data sheet

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Legal information

Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

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Tables

Tab. 1. Tab. 2. Tab. 3. Tab. 4. Tab. 5. Tab. 6.	Ordering information2Ordering options3Pin description5Address selection6Control register10Recommended supply sequencing and ramp rates11	Tab. 7. Tab. 8. Tab. 9. Tab. 10. Tab. 11. Tab. 12. Tab. 13.	Limiting values	15 17 22 22
Figure	es			
Fig. 1. Fig. 2.	Block diagram of PCA9848BS	Fig. 13.	Typical application for PCA9848BS with differing bus voltages	12
Fig. 3.	Target address	Fig. 14.	Write control register	
Fig. 4.	General Call address7	Fig. 15.	Read control register	
Fig. 5.	Device ID address7	Fig. 16.	Ron test circuit	
Fig. 6.	Software Reset sequence8	Fig. 17.	Definition of timing on the I2C-bus	18
Fig. 7.	PCA9848BS Device ID field9	Fig. 18.	Definition of RESET timing	19
Fig. 8.	Device ID field read operation9	Fig. 19.	I2C-bus timing diagram	19
Fig. 9.	Control register9	Fig. 20.	Package outline SOT616-3 (HVQFN24)	20
Fig. 10.	VDD2 is lowered below the POR threshold, then ramped back up to VDD211	Fig. 21.	Temperature profiles for large and small components	22
Fig. 11. Fig. 12.	Glitch width and glitch height	Fig. 22.	PCB footprint for SOT616-3 (HVQFN24); reflow soldering	

NXP Semiconductors

PCA9848BS

8-Channel Ultra-Low Voltage, Fm+ I2C-Bus Switch with Reset

Contents

1	General description	2
2	Features and benefits	2
3	Ordering information	
3.1	Ordering options	
4	Block diagram	
5	Pinning information	
5.1	Pinning	
5.2	Pin description	
6	Functional description	
6.1	Device address	
6.2	Software Reset General Call and Device ID	
	addresses	
6.2.1	Software Reset	
6.2.2	Device ID (PCA9848BS ID field)	
6.3	Control register	
6.3.1	Control register definition	
6.4	RESET input	
6.5	Power-on reset	10
6.6	Power-on reset requirements	11
6.7	Voltage level translation between I2C-	
	buses	12
7	Characteristics of the I2C-bus	
7.1	Write commands	13
7.2	Read commands	14
8	Limiting values	15
9	Static characteristics	15
10	Dynamic characteristics	17
11	Package outline	19
12	Soldering of SMD packages	21
12.1	Introduction to soldering	
12.2	Wave and reflow soldering	21
12.3	Wave soldering	
12.4	Reflow soldering	21
13	Soldering: PCB footprints	23
14	Acronyms	
15	Revision history	24
	Legal information	

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